FAIRCHILD SEMICONDUCTOR™

March 1998

100325
Low Power Hex ECL-to-TTL Translator

General Description

The 100325 is a hex translator for converting F100K logic levels to TTL logic levels. Differential inputs allow each circuit to be used as an inverting, non-inverting or differential receiver. An internal reference voltage generator provides V_{BB} for single-ended operation, or for use in Schmitt trigger applications. All inputs have 50kΩ pull-down resistors. When the inputs are either unconnected or at the same potential the outputs will go low.

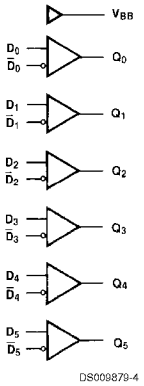
When used in single-ended operation the apparent input threshold of the true inputs is 20mV to 40mV higher (positive) than the threshold of the complementary inputs. The V_{EE} and V_{TTL} power may be applied in either order.

Features

- Pin/function compatible with 100125
- Meets 100125 AC specifications
- 50% power reduction of the 100125
- Differential inputs with built in offset
- Standard FAST® outputs
- 2000V ESD protection
- –4.2V to –5.7V operating range
- Available to industrial grade temperature range
- Available to MIL-STD-883

Ordering Code:

Logic Diagram



DS009879-4

Pin Names	Description
D_0–D_5	Data Inputs
$\overline{D}_0$–$\overline{D}_5$	Inverting Data Inputs
Q_0–Q_5	Data Outputs

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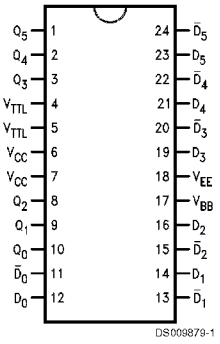
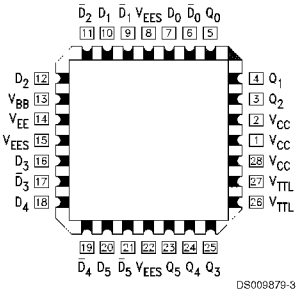
Connection Diagrams

24-Pin DIP/SOIC



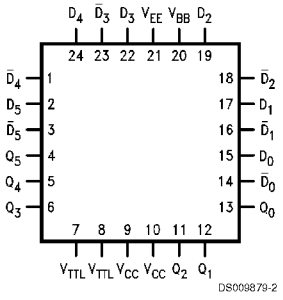
DS009879-1

28-Pin PCC



DS009879-3

24-Pin Quad Cerpak



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Truth Table

Inputs		Outputs
D_n	$\bar{D}_n$	Q_n
L	H	L
H	L	H
L	L	L
H	H	L
Open	Open	L
V_{EE}	V_{EE}	L
L	V_{BB}	L
H	V_{BB}	H
V_{BB}	L	H
V_{BB}	H	L

H = HIGH Voltage Level
L = LOW Voltage Level

Absolute Maximum Ratings (Note 1)

Above which the useful life may be impaired.

Storage Temperature (T_{STG})	−65°C to +150°C
Maximum Junction Temperature (T_J)	
Ceramic	+175°C
Plastic	+150°C
V_{EE} Pin Potential to Ground Pin	−7.0V to +0.5V
V_{TTL} Pin Potential to Ground Pin	−0.5V to +6.0V
Input Voltage (DC)	V_{EE} to +0.5V
Voltage Applied to Output	
in HIGH State (with V_{CC} = 0V)	−0.5V to V_{CC}
Current Applied to Output	
in LOW State (Max)	twice the rated I_{OL} (mA)
ESD (Note 2)	≥2000V

Recommended Operating Conditions

Case Temperature (T_C)	
Commercial	0°C to +85°C
Industrial	−40°C to +85°C
Military	−55°C to +125°C
Supply Voltage (V_{EE})	−5.7V to −4.2V

Note 1: Absolute maximum ratings are those values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: ESD testing conforms to MIL-STD-883, Method 3015.

Commercial Version

DC Electrical Characteristics

V_{EE} = −4.2V to −5.7V, V_{CC} = GND, V_{TTL} = +4.5V to 5.5V, T_C = 0°C to +85°C (Note 4)

Symbol	Parameter	Min	Typ	Max	Units	Conditions	
V_{BB}	Output Reference Voltage	−1380	−1320	−1260	mV	I_{VBB} = −2.1 mA	
V_{IH}	Single-Ended Input HIGH Voltage	−1165		−870	mV	Guaranteed HIGH Signal for All Inputs (with One Input Tied to V_{BB})	
V_{IL}	Single-Ended Input LOW Voltage	−1830		−1475	mV	Guaranteed LOW Signal for All Inputs (with One Input Tied to V_{BB})	
V_{OH}	Output HIGH Voltage	2.5			V	I_{OH} = −2.0 mA	V_{IN} = $V_{IH\ (Max)}$
V_{OL}	Output LOW Voltage			0.5	V	I_{OL} = 20 mA	or $V_{IL\ (Min)}$
V_{DIFF}	Input Voltage Differential	150			mV	Required for Full Output Swing	
V_{CM}	Common Mode Voltage	V_{CC} − 2.0		V_{CC} − 0.5	V		
I_{IH}	Input HIGH Current			350	μA	V_{IN} = $V_{IH\ (Max)}$, D_0–D_5 = V_{BB}, $\overline{D}_0$–$\overline{D}_5$ = $V_{IL\ (Min)}$	
I_{IL}	Input LOW Current	0.5			μA	V_{IN} = $V_{IL\ (Min)}$, D_0–D_5 = V_{BB}	
I_{OS}	Output Short-Circuit Current	−150		−60	mA	V_{OUT} = GND (Note 3)	
I_{EE}	V_{EE} Power Supply Current	−37	−27	−17	mA	D_0–D_5 = V_{BB}	
I_{TTL}	V_{TTL} Power Supply Current		45	65	mA	D_0–D_5 = V_{BB}	

Note 3: Test one output at a time.

Note 4: The specified limits represent the "worst case" value for the parameter. Since these values normally occur at the temperature extremes, additional noise immunity and guardbanding can be achieved by decreasing the allowable system operating ranges. Conditions for testing shown in the tables are chosen to guarantee operation under "worst case" conditions.

DIP AC Electrical Characteristics

V_{EE} = −4.2V to −5.7V, V_{CC} = GND, V_{TTL} = +4.5V to +5.5V

Symbol	Parameter	T_C = 0°C		T_C = +25°C		T_C = +85°C		Units	Conditions
		Min	Max	Min	Max	Min	Max		
t_{PLH} t_{PHL}	Propagation Delay Data to Output	0.80	3.50	0.90	3.70	1.00	4.00	ns	C_L = 15 pF *Figures 1, 2*
t_{PLH} t_{PHL}	Propagation Delay Data to Output	1.60	4.30	1.70	4.50	1.80	4.80	ns	C_L = 50 pF *Figures 1, 3*

SOIC, PCC and Cerpak AC Electrical Characteristics

V_{EE} = −4.2V to −5.7V, V_{CC} = GND, V_{TTL} = +4.5V to +5.5V

Symbol	Parameter	T_C = 0°C		T_C = +25°C		T_C = +85°C		Units	Conditions
		Min	Max	Min	Max	Min	Max		
t_{PLH} t_{PHL}	Propagation Delay Data to Output	0.80	3.30	0.90	3.50	1.00	3.80	ns	C_L = 15 pF *Figures 1, 2*
t_{PLH} t_{PHL}	Propagation Delay Data to Output	1.60	4.10	1.70	4.30	1.80	4.60	ns	C_L = 50 pF *Figures 1, 3*
t_{OSHL}	Maximum Skew Common Edge Output-to-Output Variation Data to Output Path		0.65		0.65		0.65	ns	PCC Only (Note 5)
t_{OSLH}	Maximum Skew Common Edge Output-to-Output Variation Data to Output Path		0.65		0.65		0.65	ns	PCC Only (Note 5)
t_{OST}	Maximum Skew Opposite Edge Output-to-Output Variation Data to Output Path		2.20		2.20		2.20	ns	PCC Only (Note 5)
t_{PS}	Maximum Skew Pin (Signal) Transition Variation Data to Output Path		2.10		2.10		2.10	ns	PCC Only (Note 5)

Note 5: Output-to-Output Skew is defined as the absolute value of the difference between the actual propagation delay for any outputs within the same packaged device. The specifications apply to any outputs switching in the same direction either HIGH to LOW (t_{OSHL}), or LOW to HIGH (t_{OSLH}), or in opposite directions both HL and LH (t_{OST}). Parameters t_{OST} and t_{PS} guaranteed by design.

Industrial Version

PCC DC Electrical Characteristics

V_{EE} = −4.2V to −5.7V, V_{CC} = GND, T_C = −40°C to +85°C (Note 7)

Symbol	Parameter	T_C = −40°C		T_C = 0°C to +85°C		Units	Conditions	
		Min	Max	Min	Max			
V_{BB}	Output Reference Voltage	−1395	−1255	−1380	−1260	mV	I_{VBB} = −2.1 mA	
V_{IH}	Single-Ended Input HIGH Voltage	−1170	−870	−1165	−870	mV	Guaranteed HIGH Signal for All Inputs (with One Input Tied to V_{BB})	
V_{IL}	Single-Ended Input LOW Voltage	−1830	−1480	−1830	−1475	mV	Guaranteed LOW Signal for All Inputs (with One Input Tied to V_{BB})	
V_{OH}	Output HIGH Voltage	2.5		2.5		V	I_{OH} = −2.0 mA	V_{IN} = $V_{IH\ (Max)}$
V_{OL}	Output LOW Voltage		0.5		0.5	V	I_{OL} = 20 mA	or $V_{IL\ (Min)}$
V_{DIFF}	Input Voltage Differential	150		150		mV	Required for Full Output Swing	
V_{CM}	Common Mode Voltage	V_{CC} − 2.0	V_{CC} − 0.5	V_{CC} − 2.0	V_{CC} − 0.5	V		
I_{IH}	Input HIGH Current		450		350	µA	V_{IN} = $V_{IH\ (Max)}$, D_0–D_5 = V_{BB}, $\overline{D}_0$–$\overline{D}_5$ = $V_{IL\ (Min)}$	
I_{IL}	Input LOW Current	0.5		0.5		µA	V_{IN} = $V_{IL\ (Min)}$, D_0–D_5 = V_{BB}	
I_{OS}	Output Short-Circuit Current	−150	−60	−150	−60	mA	V_{OUT} = GND (Note 6)	
I_{EE}	V_{EE} Power Supply Current	−37	−15	−37	−17	mA	D_0–D_5 = V_{BB}	
I_{TTL}	V_{TTL} Power Supply Current		65		65	mA	D_0–D_5 = V_{BB}	

Note 6: Test one output at a time.

Note 7: The specified limits represent the "worst case" value for the parameter. Since these values normally occur at the temperature extremes, additional noise immunity and guardbanding can be achieved by decreasing the allowable system operating ranges. Conditions for testing shown in the tables are chosen to guarantee operation under "worst case" conditions.

PCC AC Electrical Characteristics

V_{EE} = −4.2V to −5.7V, V_{CC} = GND, V_{TTL} = +4.5V to +5.5V

Symbol	Parameter	T_C = −40°C		T_C = +25°C		T_C = +85°C		Units	Conditions
		Min	Max	Min	Max	Min	Max		
t_{PLH} t_{PHL}	Propagation Delay Data to Output	0.80	3.30	0.90	3.50	1.00	3.80	ns	C_L = 15 pF *Figures 1, 2*
t_{PLH} t_{PHL}	Propagation Delay Data to Output	1.60	4.10	1.70	4.30	1.80	4.60	ns	C_L = 50 pF *Figures 1, 3*

Military Version

DC Electrical Characteristics

V_{EE} = −4.2V to −5.7V, V_{CC} = V_{CCA} = GND, T_C = −55°C to +125°C, C_L = 50 pF, V_{TTL} = +4.5V to +5.5V

Symbol	Parameter	Min	Max	Units	T_C	Conditions		Notes
V_{BB}	Output Reference Voltage	−1380	−1260	mV	0°C to +125°C	I_{VBB} = −3 µA, V_{EE} = −4.2V		(Notes 8, 9, 10)
						I_{VBB} = −2.1 mA	V_{EE} = −5.7V	
		−1396	−1260		−55°C	I_{VBB} = −3 mA		
V_{IH}	Input HIGH Voltage	−1165	−870	mV	−55°C to +125°C	Guaranteed HIGH Signal for All Inputs (with One Input Tied to V_{BB})		(Notes 8, 9, 10, 11)
V_{IL}	Input LOW Voltage	−1830	−1475	mV	−55°C to +125°C	Guaranteed LOW Signal for All Inputs (with One Input Tied to V_{BB})		(Notes 8, 9, 10, 11)
V_{OH}	Output HIGH Voltage	2.5		mV	0°C to +125°C	I_{OH} = −2.0 mA	V_{IN} = $V_{IH\ (Max)}$ or $V_{IL\ (Min)}$	(Notes 8, 9, 10)
		2.4			−55°C			
V_{OL}	Output LOW Voltage		0.5	mV	−55°C to +125°C	I_{OL} = 20 mA		
V_{DIFF}	Input Voltage Differential	150		mV	−55°C to +125°C	Required for Full Output Swing		(Notes 8, 9, 10)
V_{CM}	Common Mode Voltage	−2000	−500	mV	−55°C to +125°C			(Notes 8, 9, 10, 11)
I_{IH}	Input HIGH Current		350	µA	0°C to +125°C	V_{IN} = $V_{IH\ (Max)}$, D_0–D_5 = V_{BB}, $\overline{D}_0$–$\overline{D}_5$ = $V_{IL\ (Min)}$		(Notes 8, 9, 10)
			500		−55°C			
I_{IL}	Input LOW Current	0.50		µA	−55°C to +125°C	V_{IN} = $V_{IL\ (Min)}$, D_0–D_5 = V_{BB}		(Notes 8, 9, 10)
I_{OS}	Output Short Circuit Current	−150	−60	mA	−55°C to +125°C	V_{OUT} = GND Test One Output at a Time		(Notes 8, 9, 10)
I_{CEX}	Output HIGH Leakage Current		250	µA	−55°C to +125°C	V_{OUT} = 5.5V		(Notes 8, 9, 10)
I_{EE}	V_{EE} Power Supply Current	−35	−12	mA	−55°C to +125°C	D_0–D_5 = V_{BB}		(Notes 8, 9, 10)
I_{TTL}	V_{TTL} Power Supply Current		65	mA	−55°C to +125°C	D_0–D_5 = V_{BB}		(Notes 8, 9, 10)

Note 8: F100K 300 Series cold temperature testing is performed by temperature soaking (to guarantee junction temperature equals −55°C), then testing immediately without allowing for the junction temperature to stabilize due to heat dissipation after power-up. This provides "cold start" specs which can be considered a worst case condition at cold temperatures.

Note 9: Screen tested 100% on each device at −55°C, +25°C, and +125°C, Subgroups 1, 2, 3, 7, and 8.

Note 10: Sample tested (Method 5005, Table I) on each manufactured lot at −55°C, + 25°C, and +125°C, Subgroups A1, 2, 3, 7, and 8.

Note 11: Guaranteed by applying specified input condition and testing V_{OH}/V_{OL}.

AC Electrical Characteristics

V_{EE} = −4.2V to −5.7V, V_{CC} = GND, V_{TTL} = +4.5V to +5.5V

Symbol	Parameter	T_C = −55°C		T_C = +25°C		T_C = +125°C		Units	Conditions	Notes
		Min	Max	Min	Max	Min	Max			
t_{PLH} t_{PHL}	Propagation Delay Data to Output	1.50	5.00	1.60	4.70	1.70	5.70	ns	C_L = 50 pF *Figures 1, 3*	(Notes 12, 13, 14)

Note 12: F100K 300 Series cold temperature testing is performed by temperature soaking (to guarantee junction temperature equals −55°C), then testing immediately after power-up. This provides "cold start" specs which can be considered a worst case condition at cold temperatures.

Note 13: Screen tested 100% on each device at +25°C, temperature only, Subgroup A9.

Note 14: Sample tested (Method 5005, Table I) on each manufactured lot at +25°C, Subgroup A9, and at +125°C and −55°C temperatures, Subgroups A10 and A11.

AC Electrical Characteristics (Continued)

Note 15: Not tested at +25˚C, +125˚C, and −55˚C temperature (design characterization data).

Switching Waveform

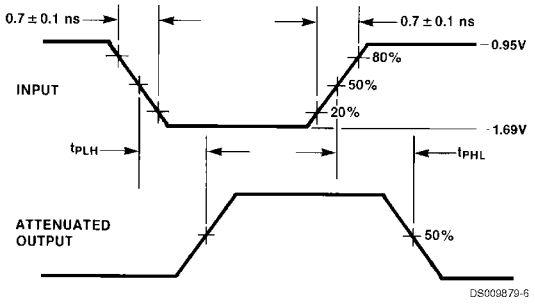
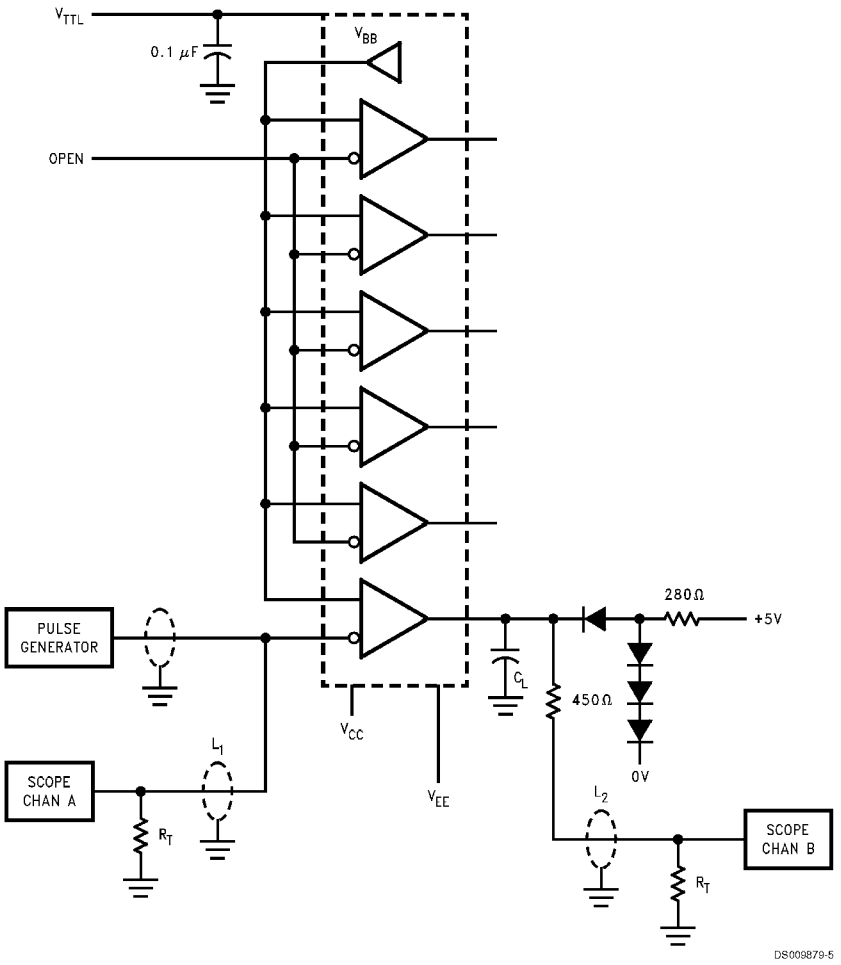


FIGURE 1. Propagation Delay

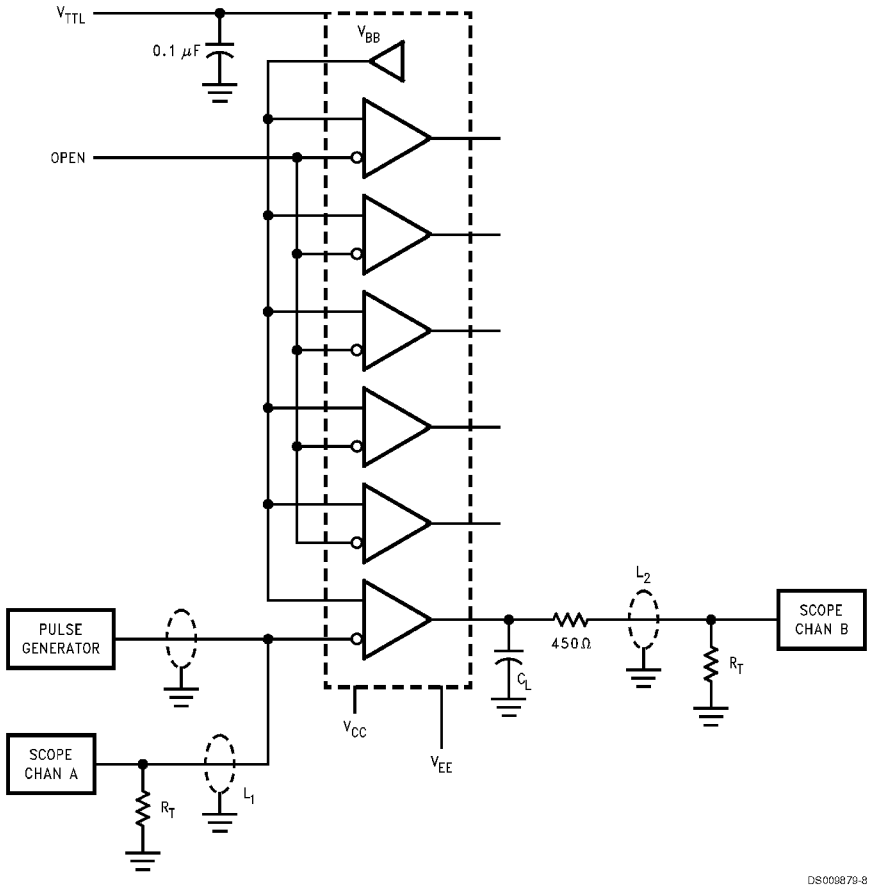
Test Circuits



Notes:
V_{CC} = 0V, V_{EE} = −4.5V, V_{TTL} = +5V
L1 and L2 = equal length 50Ω impedance lines
R_T = 50Ω terminator internal to scope
Decoupling 0.1 μF from GND to V_{CC}, V_{EE} and V_{TTL}
All unused outputs are loaded with 500Ω to GND
C_L = Fixture and stray capacitance = 15 pF

FIGURE 2. AC Test Circuit for 15 pF Loading

Test Circuits (Continued)

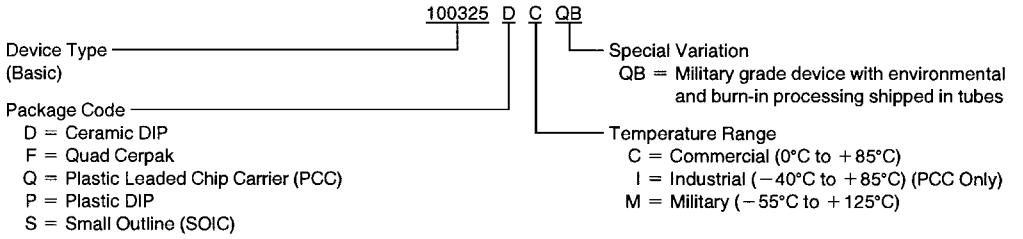


Notes:
V_{CC} = 0V, V_{EE} = −4.5V, V_{TTL} = +5V
L1 and L2 = equal length 50Ω impedance lines
R_T = 50Ω terminator internal to scope
Decoupling 0.1 μF from GND to V_{CC}, V_{EE} and V_{TTL}
All unused outputs are loaded with 500Ω to GND
C_L = Fixture and stray capacitance = 50 pF

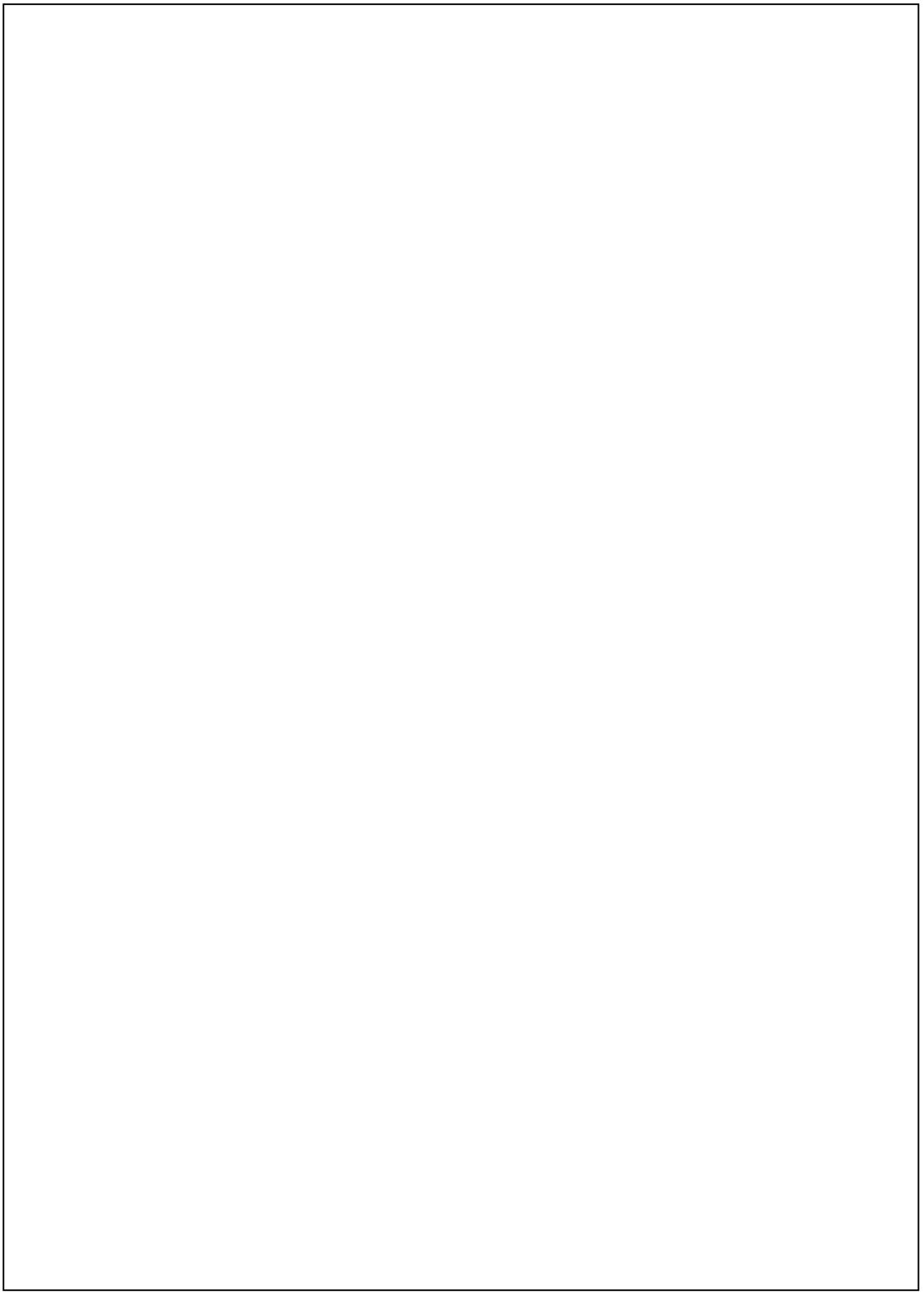
FIGURE 3. AC Test Circuit for 50 pF Loading

Ordering Information

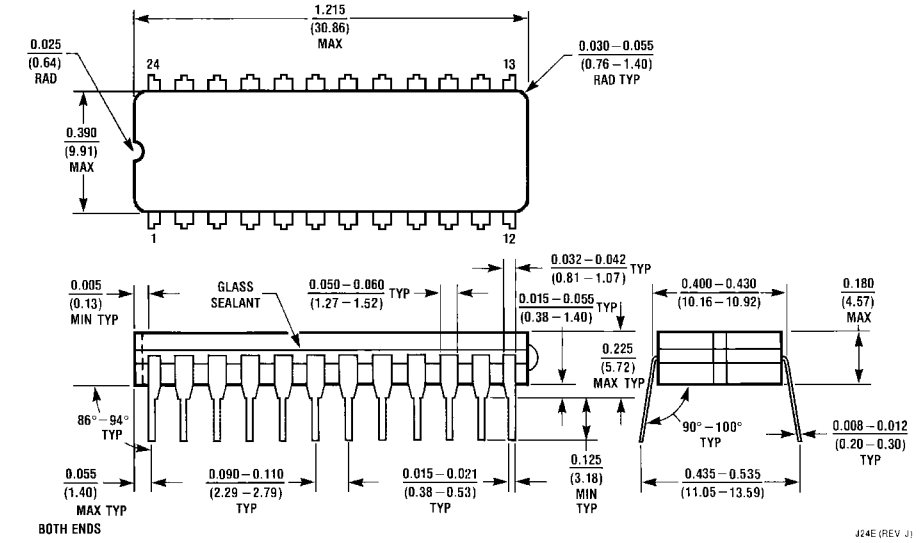
The device number is used to form part of a simplified purchasing code where a package type and temperature range are defined as follows:



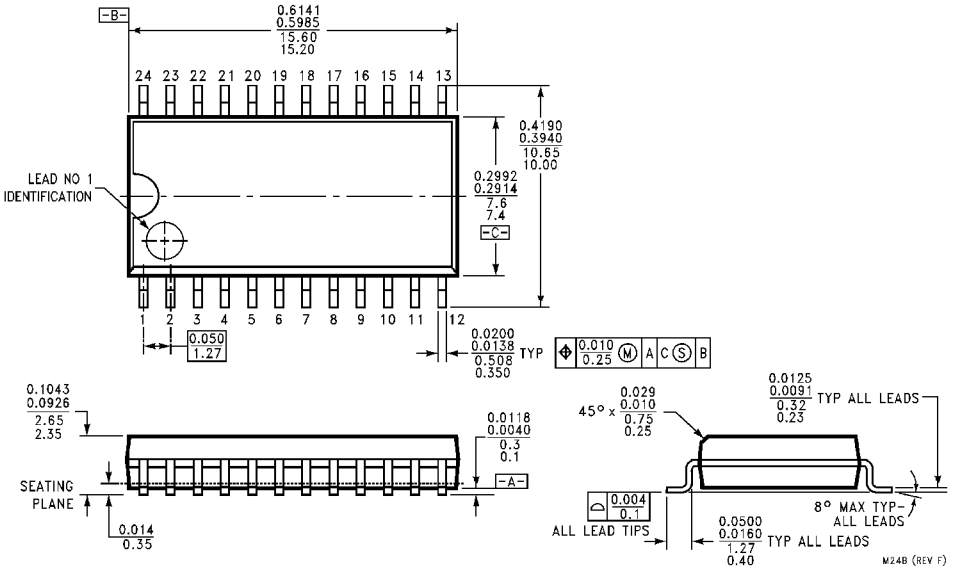
DS009879-9



Physical Dimensions inches (millimeters) unless otherwise noted

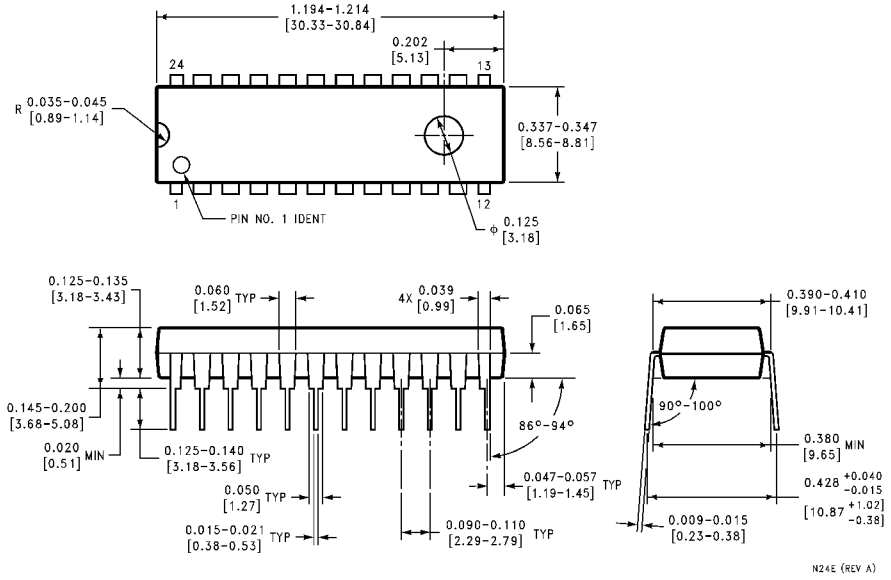


24 Lead Ceramic Dual-In-Line Package (0.400" Wide) (D)
Package Number J24E



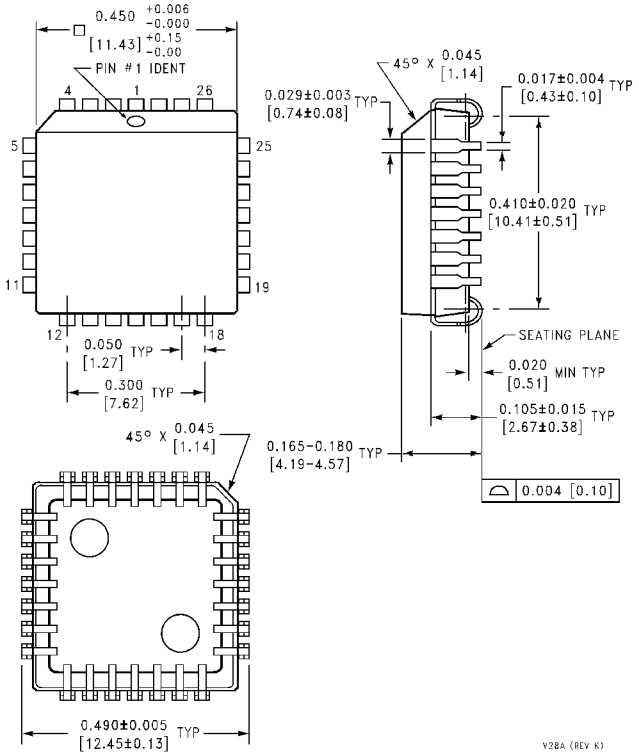
24 Lead Package (S)
Package Number M24B

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



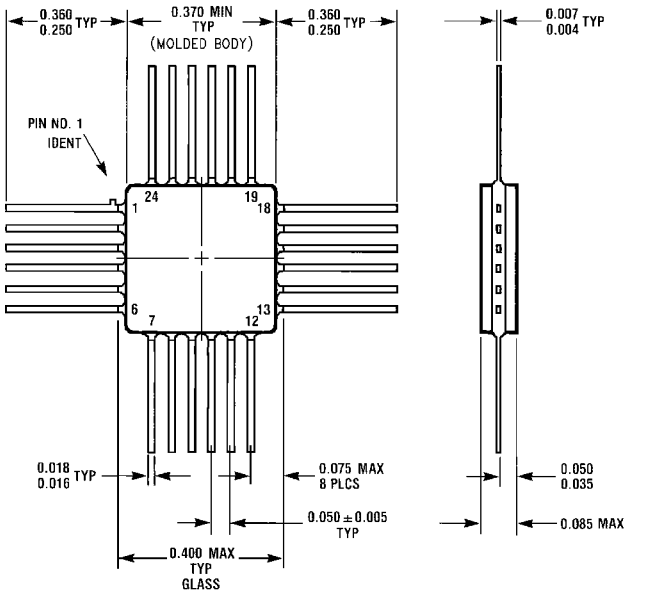
24 Lead Plastic DIP Package (P)
Package Number N24E

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



28 Lead Plastic Chip Carrier (Q)
Package Number V28A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



24 Lead Quad Cerpak (F)
Package Number W24B

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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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